

# 74LVTH322374 Low Voltage 32-Bit D-Type Flip-Flop with 3-STATE Outputs and 25Ω Series Resistors in the Outputs (Preliminary)



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### General Description

The LVTH322374 contains thirty-two non-inverting D-type flip-flops with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. A buffered clock (CP) and Output Enable ( $\overline{OE}$ ) are common to each byte and can be shorted together for full 32-bit operation.

The LVTH322374 is designed with equivalent 25Ω series resistance in both the HIGH and LOW states of the output. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus transceivers/transmitters.

The LVTH322374 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These flip-flops are designed for low voltage (3.3V)  $V_{CC}$  applications, but with the capability to provide a TTL interface to a 5V environment. The LVTH322374 is fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining a low power dissipation.

### Features

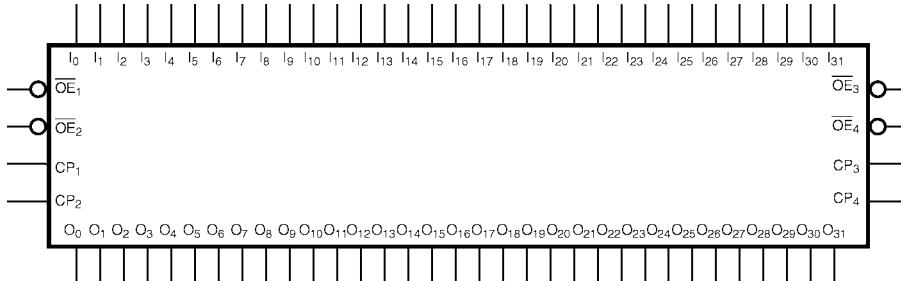
- Input and output interface capability to systems at 5V  $V_{CC}$
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power Up/Power Down high impedance provides glitch-free bus loading
- Outputs include equivalent series resistance of 25Ω to make external termination resistors unnecessary and reduce overshoot and undershoot
- ESD performance:  
Human-body model > 2000V  
Machine model > 200V  
Charged-device model > 1000V
- Packaged in plastic Fine-Pitch Ball Grid Array (FBGA) (Preliminary)

### Ordering Code:

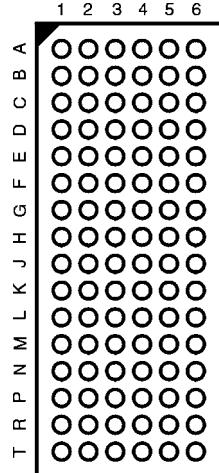
Order Number	Package Number	Package Description
74LVTH322374GX (Note 1)	BGA96A (Preliminary)	96-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide [Tape and Reel]

Note 1: BGA package available in Tape and Reel only.

### Logic Symbol



74LVTH322374

**Connection Diagram**

(Top Thru View)

**Pin Descriptions for FBGA**

Pin Names	Description
$\overline{OE}_n$	Output Enable Input (Active LOW)
$CP_n$	Clock Pulse Input
$I_0-I_{31}$	Inputs
$O_0-O_{31}$	3-STATE Outputs

**FBGA Pin Assignments**

	1	2	3	4	5	6
A	$O_1$	$O_0$	$\overline{OE}_1$	$CP_1$	$I_0$	$I_1$
B	$O_3$	$O_2$	GND	GND	$I_2$	$I_3$
C	$O_5$	$O_4$	$V_{CC1}$	$V_{CC1}$	$I_4$	$I_5$
D	$O_7$	$O_6$	GND	GND	$I_6$	$I_7$
E	$O_9$	$O_8$	GND	GND	$I_8$	$I_9$
F	$O_{11}$	$O_{10}$	$V_{CC1}$	$V_{CC1}$	$I_{10}$	$I_{11}$
G	$O_{13}$	$O_{12}$	GND	GND	$I_{12}$	$I_{13}$
H	$O_{14}$	$O_{15}$	$\overline{OE}_2$	$CP_2$	$I_{15}$	$I_{14}$
J	$O_{17}$	$O_{16}$	$\overline{OE}_3$	$CP_3$	$I_{16}$	$I_{17}$
K	$O_{19}$	$O_{18}$	GND	GND	$I_{18}$	$I_{19}$
L	$O_{21}$	$O_{20}$	$V_{CC2}$	$V_{CC2}$	$I_{20}$	$I_{21}$
M	$O_{23}$	$O_{22}$	GND	GND	$I_{22}$	$I_{23}$
N	$O_{25}$	$O_{24}$	GND	GND	$I_{24}$	$I_{25}$
P	$O_{27}$	$O_{26}$	$V_{CC2}$	$V_{CC2}$	$I_{26}$	$I_{27}$
R	$O_{29}$	$O_{28}$	GND	GND	$I_{28}$	$I_{29}$
T	$O_{30}$	$O_{31}$	$\overline{OE}_4$	$CP_4$	$I_{31}$	$I_{30}$

**Truth Tables**

Inputs			Outputs
$CP_1$	$\overline{OE}_1$	$I_0-I_7$	$O_0-O_7$
/	L	H	H
/	L	L	L
L	L	X	$O_o$
X	H	X	Z

Inputs			Outputs
$CP_2$	$\overline{OE}_2$	$I_8-I_{15}$	$O_8-O_{15}$
/	L	H	H
/	L	L	L
L	L	X	$O_o$
X	H	X	Z

Inputs			Outputs
$CP_3$	$\overline{OE}_3$	$I_{16}-I_{23}$	$O_{16}-O_{23}$
/	L	H	H
/	L	L	L
L	L	X	$O_o$
X	H	X	Z

Inputs			Outputs
$CP_4$	$\overline{OE}_4$	$I_{24}-I_{31}$	$O_{24}-O_{31}$
/	L	H	H
/	L	L	L
L	L	X	$O_o$
X	H	X	Z

H = HIGH Voltage Level

L = LOW Voltage Level

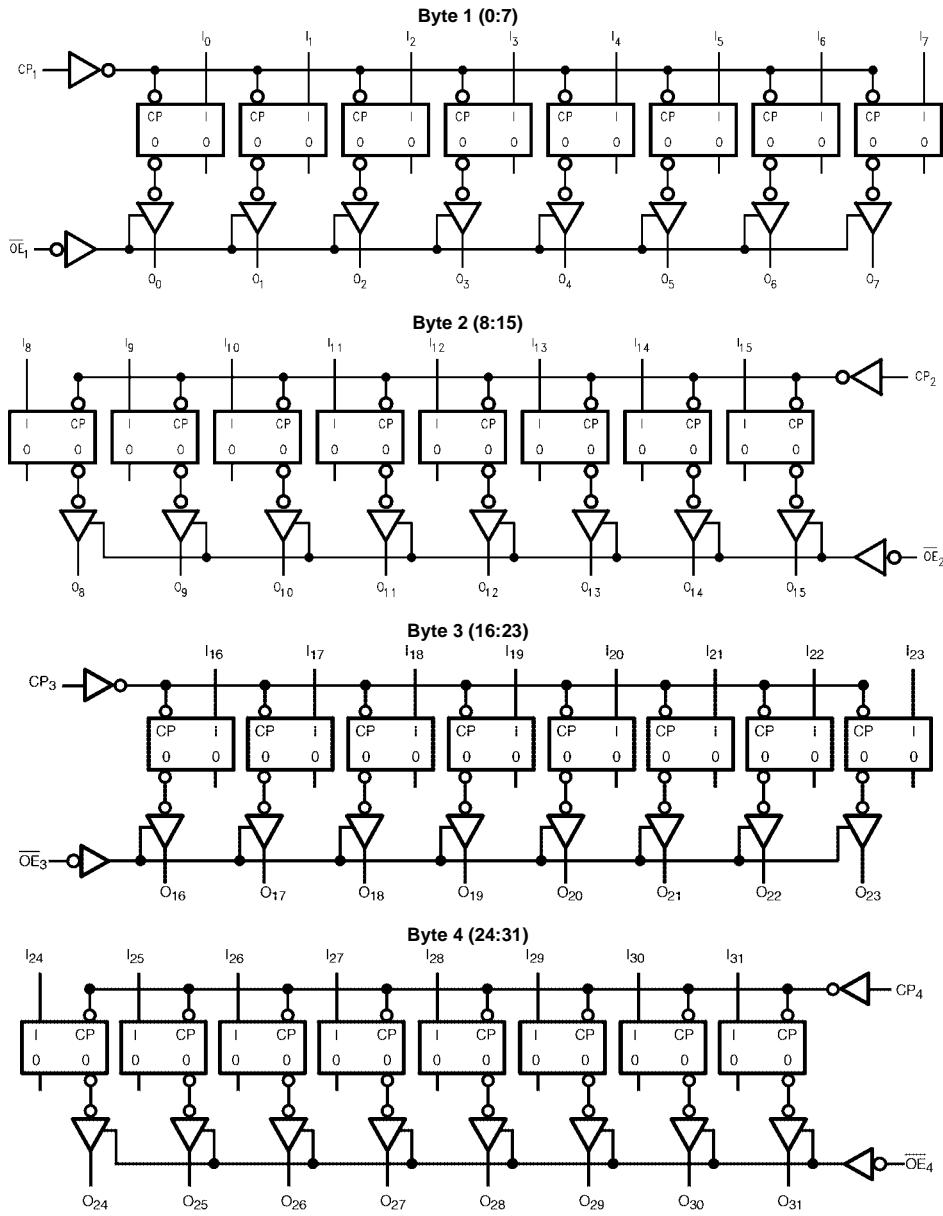
X = Immortal

Z = HIGH Impedance

 $O_o$  = Previous  $O_o$  before HIGH-to-LOW of CP**Functional Description**

The LVTH322374 consists of thirty-two edge-triggered flip-flops with individual D-type inputs and 3-STATE true outputs. The device is byte controlled with each byte functioning identically, but independent of the other. The control pins can be shorted together to obtain full 32-bit operation. Each byte has a buffered clock and buffered Output Enable common to all flip-flops within that byte. The description which follows applies to each byte. Each flip-flop will store the state of their individual D-type inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock ( $CP_n$ ) transition. With the Output Enable ( $\overline{OE}_n$ ) LOW, the contents of the flip-flops are available at the outputs. When  $\overline{OE}_n$  is HIGH, the outputs go to the high impedance state. Operation of the  $\overline{OE}_n$  input does not affect the state of the flip-flops.

## Logic Diagrams



V<sub>CC1</sub> is associated with Bytes 1 and 2.

V<sub>CC2</sub> is associated with Bytes 3 and 4.

**Note:** Please note that these diagrams are provided for the understanding of logic operation and should not be used to estimate propagation delays.

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**Absolute Maximum Ratings**(Note 2)

Symbol	Parameter	Value	Conditions	Units
$V_{CC}$	Supply Voltage	-0.5 to +4.6		V
$V_I$	DC Input Voltage	-0.5 to +7.0		V
$V_O$	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE	V
		-0.5 to +7.0	Output in HIGH or LOW State (Note 3)	
$I_{IK}$	DC Input Diode Current	-50	$V_I < GND$	mA
$I_{OK}$	DC Output Diode Current	-50	$V_O < GND$	mA
$I_O$	DC Output Current	64	$V_O > V_{CC}$ Output at HIGH State	mA
		128	$V_O > V_{CC}$ Output at LOW State	
$I_{CC}$	DC Supply Current per Supply Pin	$\pm 64$		mA
$I_{GND}$	DC Ground Current per Ground Pin	$\pm 128$		mA
$T_{STG}$	Storage Temperature	-65 to +150		°C

**Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Units
$V_{CC}$	Supply Voltage	2.7	3.6	V
$V_I$	Input Voltage	0	5.5	V
$I_{OH}$	HIGH Level Output Current		-32	mA
$I_{OL}$	LOW Level Output Current		64	mA
$T_A$	Free-Air Operating Temperature	-40	85	°C
$\Delta t/\Delta V$	Input Edge Rate, $V_{IN} = 0.8V - 2.0V$ , $V_{CC} = 3.0V$	0	10	ns/V

**Note 2:** Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

**Note 3:**  $I_O$  Absolute Maximum Rating must be observed.

**DC Electrical Characteristics**

Symbol	Parameter	$V_{CC}$ (V)	$T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}$		Units	Conditions
			Min	Max		
$V_{IK}$	Input Clamp Diode Voltage	2.7		-1.2	V	$I_I = -18 \text{ mA}$
$V_{IH}$	Input HIGH Voltage	2.7–3.6	2.0		V	$V_O \leq 0.1V$ or $V_O \geq V_{CC} - 0.1V$
$V_{IL}$	Input LOW Voltage	2.7–3.6		0.8	V	$I_{OH} = -100 \mu\text{A}$ $I_{OH} = -12 \text{ mA}$
$V_{OH}$	Output HIGH Voltage	2.7–3.6	$V_{CC} - 0.2$		V	$I_{OL} = 100 \mu\text{A}$ $I_{OL} = 12 \text{ mA}$
		3.0	2.0			
$V_{OL}$	Output LOW Voltage	2.7		0.2	V	$I_{OL} = 100 \mu\text{A}$ $I_{OL} = 12 \text{ mA}$
		3.0		0.8		
$I_{I(HOLD)}$	Bushold Input Minimum Drive	3.0	75		$\mu\text{A}$	$V_I = 0.8V$ $V_I = 2.0V$
			-75			
$I_{I(OD)}$	Bushold Input Over-Drive Current to Change State	3.0	500		$\mu\text{A}$	(Note 4) (Note 5)
			-500			
$I_I$	Input Current	3.6		10	$\mu\text{A}$	$V_I = 5.5V$ $V_I = 0V \text{ or } V_{CC}$ $V_I = 0V$ $V_I = V_{CC}$
		Control Pins	3.6	$\pm 1$		
		Data Pins	3.6	-5		
				1		
$I_{OFF}$	Power Off Leakage Current	0		$\pm 100$	$\mu\text{A}$	$0V \leq V_I \text{ or } V_O \leq 5.5V$
$I_{PU/PD}$	Power Up/Down 3-STATE Output Current	0–1.5V		$\pm 100$	$\mu\text{A}$	$V_O = 0.5V \text{ to } 3.0V$ $V_I = GND \text{ or } V_{CC}$
$I_{OZL}$	3-STATE Output Leakage Current	3.6		-5	$\mu\text{A}$	$V_O = 0.5V$
$I_{OZH}$	3-STATE Output Leakage Current	3.6		5	$\mu\text{A}$	$V_O = 3.0V$
$I_{OZH^+}$	3-STATE Output Leakage Current	3.6		10	$\mu\text{A}$	$V_{CC} < V_O \leq 5.5V$
$I_{CC1}$	Power Supply Current ( $V_{CC1}$ or $V_{CC2}$ )	3.6		0.19	mA	Outputs HIGH
$I_{CCL}$	Power Supply Current ( $V_{CC1}$ or $V_{CC2}$ )	3.6		5	mA	Outputs LOW
$I_{CCZ}$	Power Supply Current ( $V_{CC1}$ or $V_{CC2}$ )	3.6		0.19	mA	Outputs Disabled

### DC Electrical Characteristics (Continued)

Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = -40°C to +85°C		Units	Conditions
			Min	Max		
I <sub>CCZ+</sub>	Power Supply Current (V <sub>CC1</sub> or V <sub>CC2</sub> )	3.6		0.19	mA	V <sub>CC</sub> ≤ V <sub>O</sub> ≤ 5.5V, Outputs Disabled
ΔI <sub>CC</sub>	Increase in Power Supply Current (V <sub>CC1</sub> or V <sub>CC2</sub> ) (Note 6)	3.6		0.2	mA	One Input at V <sub>CC</sub> - 0.6V Other Inputs at V <sub>CC</sub> or GND

Note 4: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 5: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 6: This is the increase in supply current for each input that is at the specified voltage level rather than V<sub>CC</sub> or GND.

### Dynamic Switching Characteristics (Note 7)

Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = 25°C			Units	Conditions C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500Ω
			Min	Typ	Max		
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	3.3		0.8		V	(Note 8)
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	3.3		-0.8		V	(Note 8)

Note 7: Characterized in SSOP package. Guaranteed parameter, but not tested.

Note 8: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

### AC Electrical Characteristics

Symbol	Parameter	T <sub>A</sub> = -40°C to +85°C, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500Ω				Units	
		V <sub>CC</sub> = 3.3V ± 0.3V		V <sub>CC</sub> = 2.7V			
		Min	Max	Min	Max		
f <sub>MAX</sub>	Maximum Clock Frequency	160		160		MHz	
t <sub>PHL</sub>	Propagation Delay CP to O <sub>n</sub>	2.2	4.9	2.2	5.1	ns	
t <sub>TPLH</sub>		2.0	5.3	2.0	6.2		
t <sub>PZL</sub>	Output Enable Time	1.8	4.9	1.8	6.0	ns	
t <sub>PZH</sub>		1.8	5.6	1.8	6.9		
t <sub>TPLZ</sub>	Output Disable Time	2.0	5.0	2.0	5.1	ns	
t <sub>PHZ</sub>		2.4	5.4	2.4	5.7		
t <sub>S</sub>	Setup Time	1.8		2.0		ns	
t <sub>H</sub>	Hold Time	0.8		0.1		ns	
t <sub>W</sub>	Pulse Width	3.0		3.0		ns	

### Capacitance (Note 9)

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	V <sub>CC</sub> = OPEN, V <sub>I</sub> = 0V or V <sub>CC</sub>	4	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>CC</sub> = 3.0V, V <sub>O</sub> = 0V or V <sub>CC</sub>	8	pF

Note 9: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.

## Preliminary

### 74LVTH322374 Low Voltage 32-Bit D-Type Flip-Flop with 3-STATE Outputs and 25Ω Series Resistors in the Outputs (Preliminary)

